

Circuit protection for aerospace & defense applications

## **High Reliability Fuses**

## **Features**

- Thick film fusible element construction with glass arc suppressing system
- Designed and screened specifically for high reliability applications where failure is not an option
- QPL approved to MIL-PRF-23419/12, MIL-PRF-23419/13, with MIL-PRF-23419/14 available in 2025

## **Applications**

- Military and commercial satellites and spacecraft
- Protection of power supplies, batteries, and solar arrays
- Isolation of redundant and branch circuits



## **Features**

- Eliminates tin whiskers on surface mount component terminations
- Sn/Pb conversion process maintains component dimensional requirements
- Components experience no thermal or mechanical stresses during processing
- · Ideal for chip capacitors, resistors, and inductors





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